

# 2SK3068

Chopper Regulator DC-DC Converter, and Motor Drive Applications

Unit: mm

- Low drain-source ON resistance :  $R_{DS(ON)} = 0.4 \Omega$  (typ.)
- High forward transfer admittance :  $|Y_{fs}| = 9.0 S$  (typ.)
- Low leakage current :  $I_{DSS} = 100 \mu A$  (max) ( $V_{DS} = 500 V$ )
- Enhancement mode :  $V_{th} = 2.0 \sim 4.0 V$  ( $V_{DS} = 10 V$ ,  $I_D = 1 mA$ )

## Absolute Maximum Ratings ( $T_a = 25^\circ C$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	500	V
Drain-gate voltage ( $R_{GS} = 20 k\Omega$ )		$V_{DGR}$	500	V
Gate-source voltage		$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	12	A
	Pulse (Note 1)	$I_{DP}$	48	A
Drain power dissipation ( $T_c = 25^\circ C$ )		$P_D$	100	W
Single pulse avalanche energy (Note 2)		$E_{AS}$	364	mJ
Avalanche current		$I_{AR}$	12	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	10	mJ
Channel temperature		$T_{ch}$	150	$^\circ C$
Storage temperature range		$T_{stg}$	$-55 \sim 150$	$^\circ C$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Thermal Characteristics

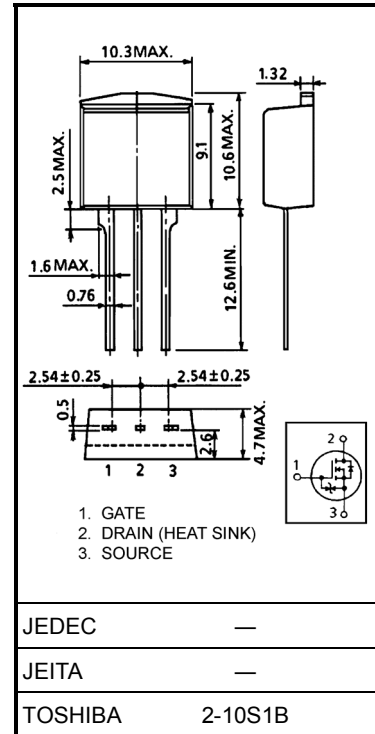
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	1.25	$^\circ C / W$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	83.3	$^\circ C / W$

Note 1: Ensure that the channel temperature does not exceed  $150^\circ C$ .

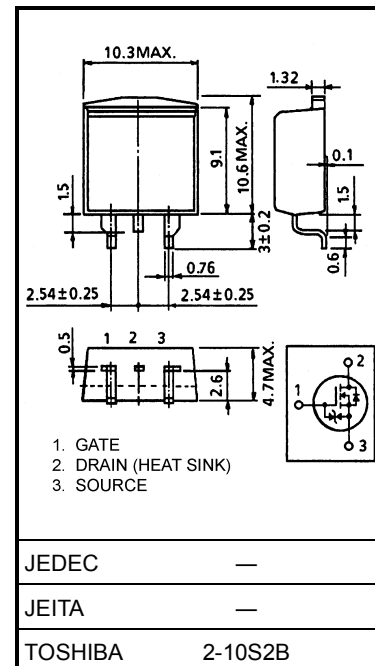
Note 2:  $V_{DD} = 90 V$ ,  $T_{ch} = 25^\circ C$  (initial),  $L = 4.3 mH$ ,  $R_G = 25 \Omega$ ,  $I_{AR} = 12 A$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device.  
Please handle with caution.

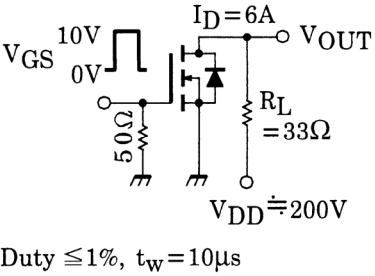


Weight: 1.5 g (typ.)



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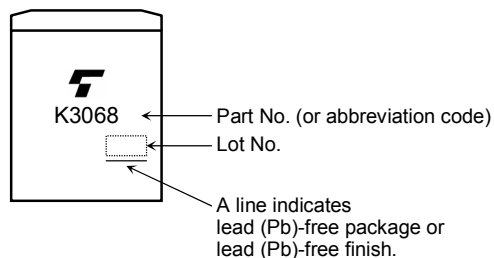
## Electrical Characteristics (Ta = 25°C)

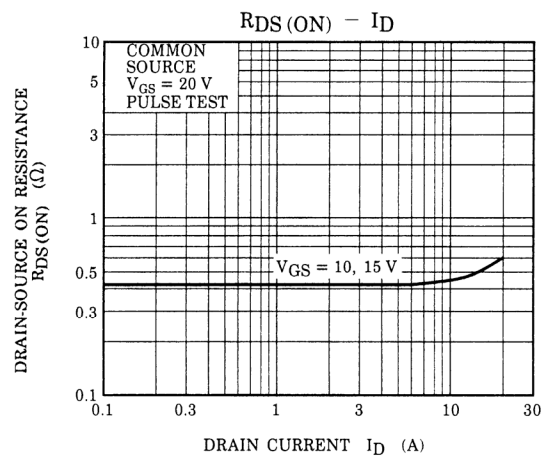
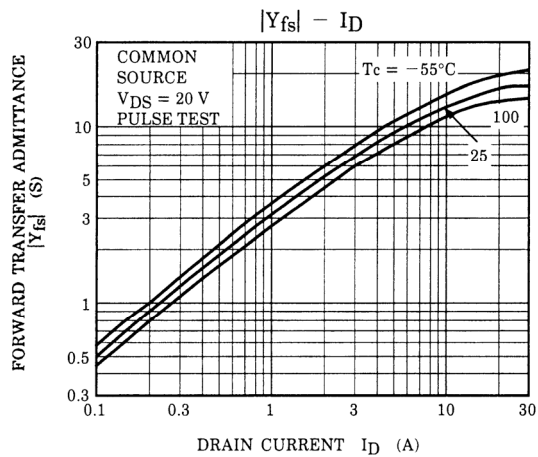
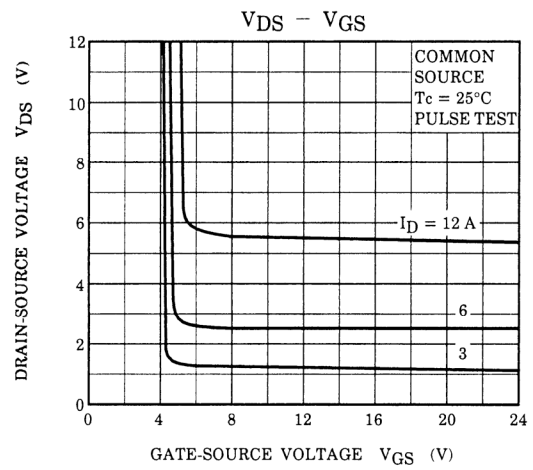
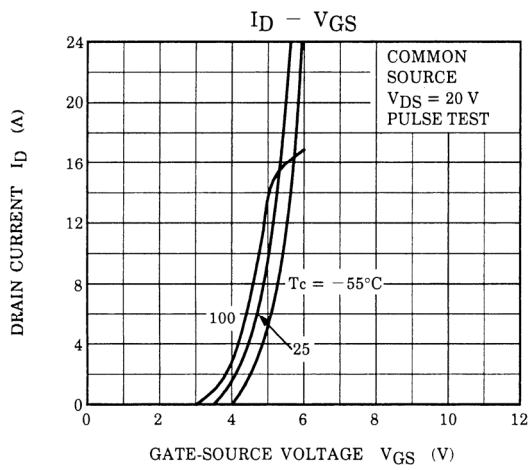
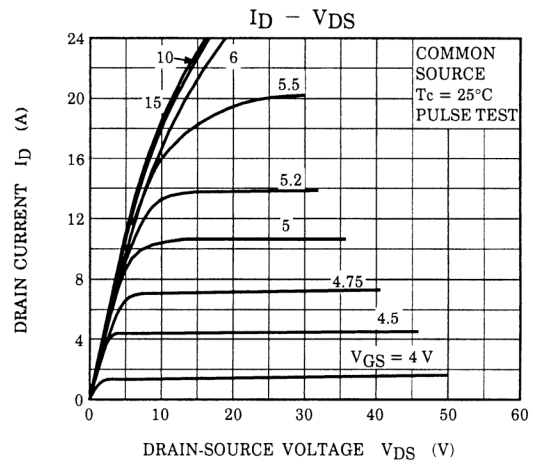
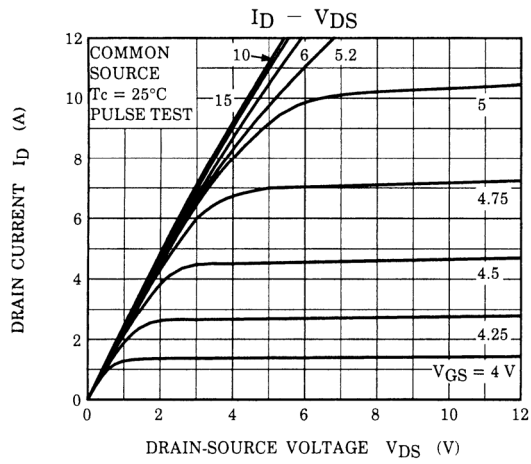
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Gate-source breakdown voltage		$V_{(BR) GSS}$	$I_G = \pm 10 \mu\text{A}, V_{DS} = 0 \text{ V}$	$\pm 30$	—	—	V
Drain cut-off current		$I_{DSS}$	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR) DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$	—	0.4	0.52	$\Omega$
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10 \text{ V}, I_D = 6 \text{ A}$	4.0	9.0	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	2040	—	pF
Reverse transfer capacitance		$C_{rss}$		—	200	—	
Output capacitance		$C_{oss}$		—	640	—	
Switching time	Rise time	$t_r$	 <p><math>I_D = 6 \text{ A}</math>  <math>V_{GS} = 10 \text{ V}</math>  <math>V_{DS} = 0 \text{ V}</math>  <math>50 \Omega</math>  <math>R_L = 33 \Omega</math>  <math>V_{DD} = 200 \text{ V}</math>  <math>\text{Duty} \leq 1\%, t_w = 10 \mu\text{s}</math></p>	—	22	—	ns
	Turn-on time	$t_{on}$		—	58	—	
	Fall time	$t_f$		—	36	—	
	Turn-off time	$t_{off}$		—	180	—	
Total gate charge (Gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	—	45	—	nC
Gate-source charge		$Q_{gs}$		—	25	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	20	—	

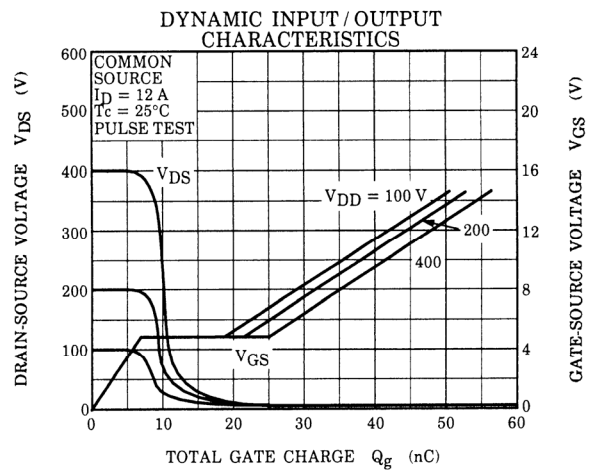
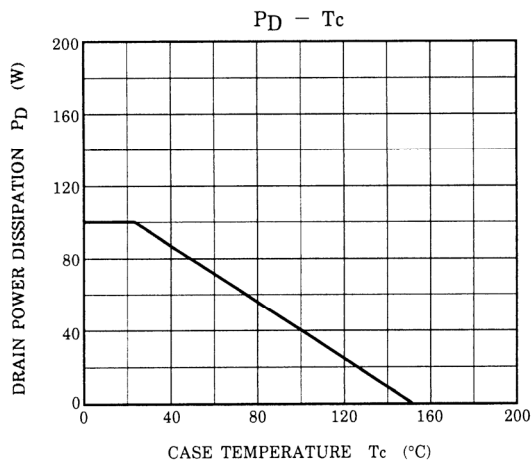
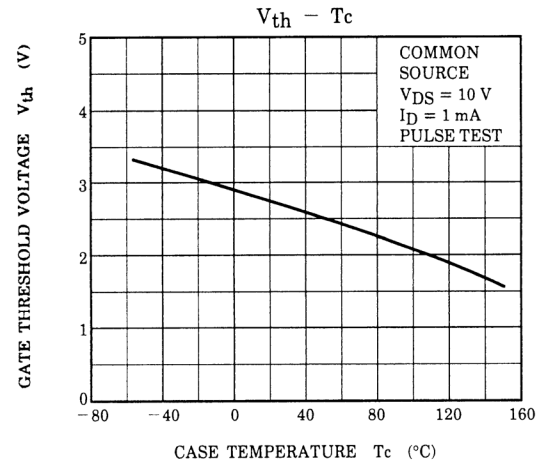
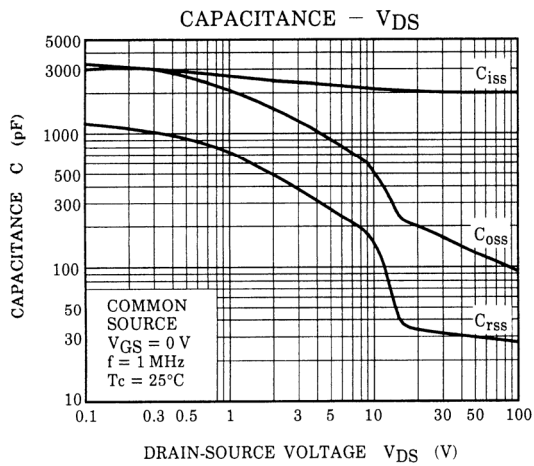
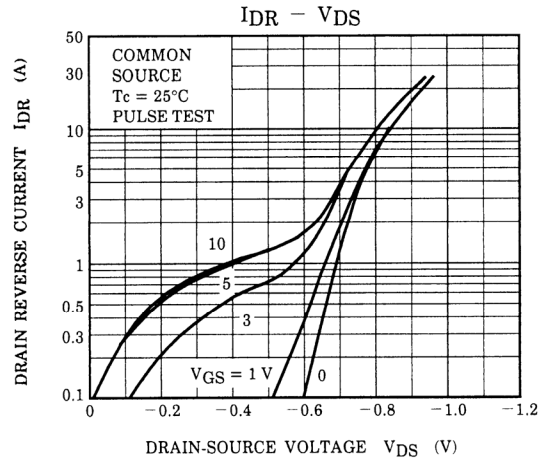
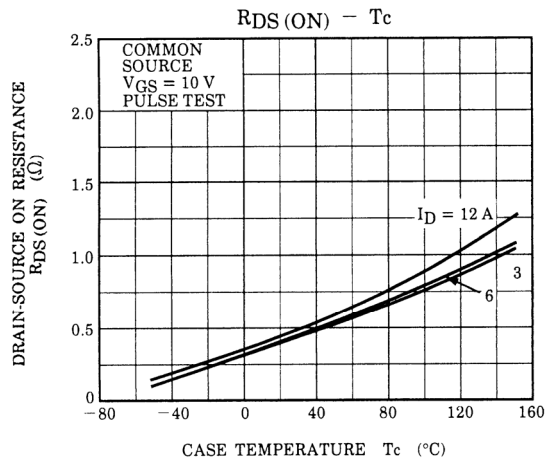
## Source-Drain Ratings and Characteristics (Ta = 25°C)

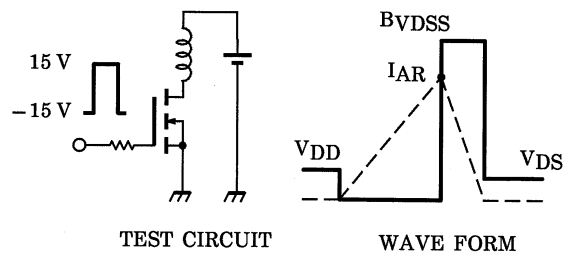
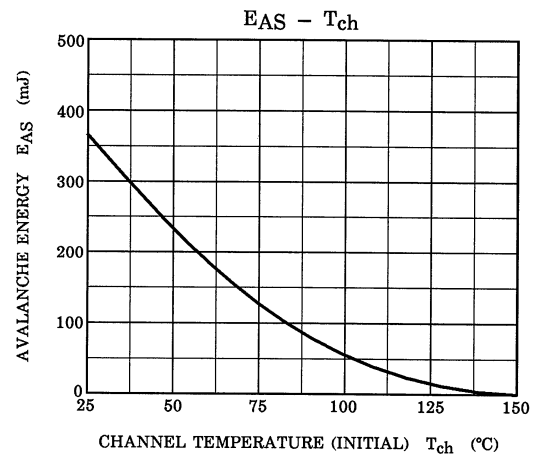
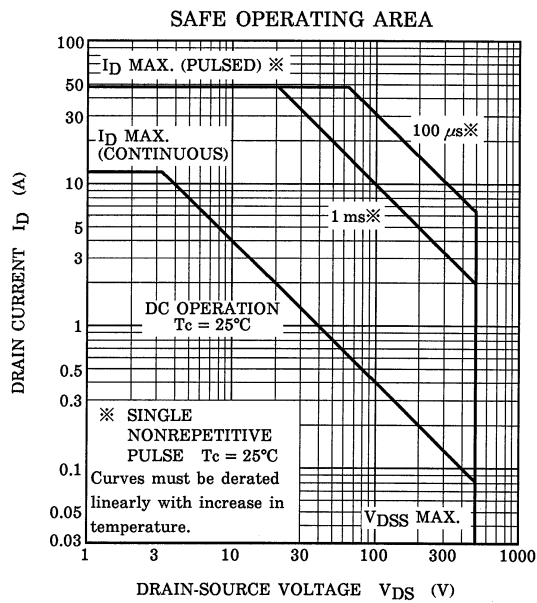
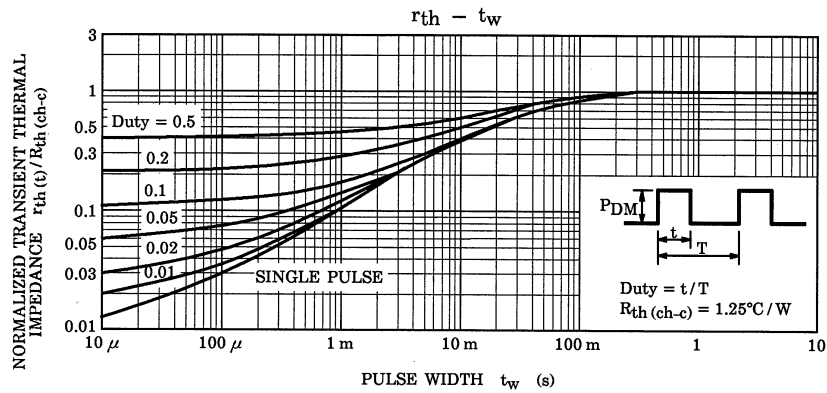
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	12	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	48	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V}$ $dI_{DR} / dt = 100 \text{ A} / \mu\text{s}$	—	370	—	ns
Reverse recovery charge	$Q_{rr}$		—	3.5	—	$\mu\text{C}$

## Marking









$$R_G = 25 \, \Omega$$

$$V_{DD} = 90 \, \text{V}, L = 4.3 \, \text{mH}$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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